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भारत सरकार, रक्षा मंत्रालय  
रक्षा अनुसंधान तथा विकास संगठन  
प्रौद्योगिकी विकास निधि निदेशालय  
कमरा न० 313, डीआरडीओ भवन  
नई दिल्ली 110011



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Govt. Of India, Ministry of Defence  
Defence R & D Organisation  
Directorate of TDF  
Room No.313, DRDO Bhawan  
New Delhi-110011

**Project No DTDF/06/13845/IN/RF Components/X/R/M/01**

**Project Name: Development of RF Components for EW Systems**

### **Bid Submission Guidelines**

1. Bid Submission Guidelines - Annexure-1
2. Template for envelopes - Annexure - 2
3. Bid Opening Date: 12<sup>th</sup> Nov 2024
4. Bid Closing Date: 11<sup>th</sup> Dec 2024 (1700 Hrs)
5. Technical Interaction Meeting date - 25<sup>th</sup> Nov 2024 at DRDO Bhawan,  
Rajaji Marg, New Delhi at 1000 Hrs
6. Single point of Contact:
  - i. Name: Ms. Hetal G Borisagar
  - ii. E Mail ID : [hetal.hqr@gov.in](mailto:hetal.hqr@gov.in)
  - iii. CC for Mail ID : [director.tdf-drdo@gov.in](mailto:director.tdf-drdo@gov.in), [shiv.hqr@gov.in](mailto:shiv.hqr@gov.in)

**Note: Each page of Technical Bid – Part A and Financial Bid  
– Part B needs to be signed and stamped by industry**

**GENERAL INFORMATION ON SUBMISSION OF BIDS UNDER TDF**

The sealed bids (**Technical bid- Part A and Financial bid- Part B**) in separate envelopes should be deposited/reach by the due date and time. The responsibility to ensure this lies with the industry. Acceptance of Special Terms & Conditions and Eligibility Criteria compliance

**1. Manner of depositing the Bids:**

Sealed bids should be dropped in the Tender Box marked as 'Invitation of bids' or sent by registered post at the address given for envelope so as to reach by the due date and time. Late Bids will not be considered. No responsibility will be taken for postal delay or non-delivery or non-receipt of bid documents. Bids sent by FAX or e-mail will not be considered (unless they have been specifically called for by these modes due to urgency).

**2. Location of the Tender Box: DRDO BHAWAN, RAJAJI MARG NEW DELHI**

Only those bids that are found in the tender box will be opened.

**3. Place of opening of the Bids: DRDO BHAWAN, RAJAJI MARG NEW DELHI**

**4. Marking of Bids:**

Bids must be clearly marked with:

(i) Project No.

(ii) Project Name

(iii) Type of bid (Technical- Part A and Financial-Part B).

The Template for Marking is provided as Annexure -2

**5. In Financial bid, all quotation has to be in Indian Rupees. All Amounts to be written in numeral as well as words.**

**6. Acceptance of Special Terms & Conditions and Eligibility Criteria compliance on Industry's Letter Head to be submitted along with Technical Bid Part-A.**

**7. Undertaking and Non-Disclosure Agreement to be submitted in advance for obtaining Functional & Operational Requirements (Refer Para 4: System requirements and Functionalities of Project Definition Document – PDD). A signed advance copy may be submitted through email mentioned below in point 8 followed by ink signed original copy to be handed over in person to Room No 313/312, DRDO Bhawan, Rajaji Marg, New Delhi.**

**8. Withdrawal of Bids:**

A bidder may withdraw its bid after submission provided that the written notice of withdrawal is received by the DTDF prior to deadline prescribed for submission of bids. A withdrawal notice may be sent by fax but it should be followed by a signed confirmation copy to be sent by post and such signed confirmation should reach DTDF not later than the deadline for submission of bids. No bid shall be modified after the deadline for submission of bids.

**Email:** [hetal.hqr@gov.in](mailto:hetal.hqr@gov.in), CC to: [director.tdf-drdo@gov.in](mailto:director.tdf-drdo@gov.in), [shiv.hqr@gov.in](mailto:shiv.hqr@gov.in)

**Fax No.:** 01123013462

**9. Rejection of Bids:**

Canvassing by the Bidder in any form, unsolicited letter and post-tender correction may invoke summary rejection. Conditional tenders will be rejected.

Seal of Industry with Date

Name of authorized Signatory  
Industry Name  
Address

**Technology Development Fund Scheme**

**Technical Bid  
Part -A of Detailed Project Report (DPR)**

**Project No : DTFD/06/13845/IN/RF Components/X/R/M/01**

**Name of Industry :**

**Title of Project : Development of RF Components for EW Systems**

**To,**

**The Director**

**Directorate of Technology Development Fund (DTDF)**

**C/o Director, Directorate of Management Services (DMS)**

**DRDO Bhawan5**

**Rajaji Marg, New Delhi – 110011**

**From,**

**Address of the Industry**

**Technology Development Fund Scheme**

**Financial Bid  
Part -B of Detailed Project Report (DPR)**

**Project No : DTFD/06/13845/IN/RF Components/X/R/M/01**

**Name of Industry :**

**Title of Project : Development of RF Components for EW Systems**

**To,  
The Director  
Directorate of Technology Development Fund (DTDF)  
C/o Director, Directorate of Management Services (DMS)  
DRDO Bhawan  
Rajaji Marg, New Delhi – 110011**

**From,  
Address of the Industry**